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Power Profiling

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1 **TECHNICAL FIELD**

2 The present disclosure generally relates to prolonging battery life in mobile
3 devices, and more particularly, to profiling the power consumption of instructions
4 executing on such devices.

5

6 **BACKGROUND**

7 Power consumption on portable devices (e.g., notebook computers, sub-
8 notebook computers, cell phones, PDA's, etc.) is of significant importance to users.
9 After all, the extent to which power is available on such devices is the extent to
10 which one might consider them to be portable. The occasional exception to this
11 generalization may be notebook computers that are used as desktop-replacement
12 computers. In this scenario, some users simply expect to move such notebook
13 computers from one power outlet to another, thus reducing the need for dependable
14 portable power. However, the majority of users generally expect to use notebook
15 computers and other portable devices in mobile settings where power outlets are
16 not available.

17 Components used in such devices can draw significant power. For
18 example, components in a typical notebook can draw 25 watts or more while the
19 notebook runs certain applications. Power consumption is important not only
20 because it determines how long the battery will last, but also because there are
21 limits to how much heat a notebook case can dissipate and still remain comfortable
22 to touch. Heat is less of a problem with PDAs and cell phones, but these devices
23 are expected to have much longer battery life, so power consumption is still a
24 major concern.

1 Component makers providing components for such portable devices
2 continually strive to reduce the amount of power their components require in order
3 to conserve battery power. For example, a chipmaker for notebook computers may
4 incorporate power saving features such as an ability to automatically reduce the
5 clock speed and the voltage level of a processor when a notebook computer is in a
6 “sleep” mode or when it is switched from AC power to battery power. Other
7 power saving features may include embedding certain software functions in
8 separate hardware chips, shutting down blocks of circuitry when they are not in
9 use (e.g., the radio portion of a chip in a cell phone), turning off hardware
10 components when they have not been used for a certain period of time (e.g.,
11 turning off a display screen), and so on.

12 While these power saving features provide some advantages, they generally
13 fail to address the problem of how to reduce power consumption in a normal
14 “runtime” environment, and/or they have other disadvantages. For example,
15 reducing the clock speed and the voltage level of a processor when a notebook
16 computer is in a sleep mode or running on battery power may adversely affect the
17 performance of certain applications. The use of additional hardware to embed
18 certain software functions requires additional space and cost for the hardware.
19 Shutting down blocks of circuitry and other hardware (e.g., a display screen) that
20 are not in use for a certain period of time only saves power when these components
21 are not being used. Thus, current methods do not address the problem of reducing
22 the normal runtime power consumption of such portable devices, nor do they offer
23 any useful information about how software executing on such devices consumes
24 power.

25

1 Furthermore, current mobile application and embedded development tools
2 do not provide a mechanism for profiling power consumption of software
3 executing on such mobile devices. Conventional techniques for monitoring and
4 optimizing power consumption on such devices require labor intensive hardware
5 tracing and software debugging using oscilloscopes and logic analyzers. Such
6 techniques do not help to isolate exact locations in software code where power
7 consumption may be excessive.

8 Accordingly, the need exists for a way to profile the power consumption of
9 particular software as it is executed in order to help reduce power consumption in
10 embedded, battery powered devices.

11

12 **SUMMARY**

13 Power profiling of software execution is described herein.

14 In accordance with one implementation, instructions executing on a
15 processor are identified. Power consumption data is received from a power
16 measurement circuit and correlated with the identified instructions.

17 In accordance with another implementation, a power profile is generated.
18 The power profile includes a plurality of power consumption values and a plurality
19 of identified instructions. Each value of power consumption is associated in the
20 power profile with an identified instruction.

21

22 **BRIEF DESCRIPTION OF THE DRAWINGS**

23 The same reference numerals are used throughout the drawings to reference
24 like components and features.

1 Fig. 1 illustrates an exemplary development environment 100 that is
2 suitable for implementing power profiling.

3 Fig. 2 illustrates an exemplary embodiment of a target device, host
4 computer, and power measurement circuit configured to implement power
5 profiling.

6 Fig. 3 illustrates an analog to digital converter of a power measurement
7 circuit configured to measure the power consumption of an embedded device.

8 Fig. 4 illustrates an example of a graphical user interface that might be
9 generated by a power profiler to communicate power consumption information.

10 Fig. 5 illustrates another exemplary embodiment of a target device, host
11 computer, and power measurement circuit configured to implement power
12 profiling.

13 Figs. 6 - 8 illustrate block diagrams of exemplary methods for implementing
14 power profiling of software instructions executing on a processor.

15 Fig. 9 illustrates an exemplary computing environment suitable for
16 implementing a target embedded device and a host computer.

17

18 **DETAILED DESCRIPTION**

19 **Overview**

20 The following discussion is directed to systems and methods for profiling
21 the power consumption of software instructions executing on a processor. A power
22 measurement circuit records power consumption levels of a processor executing
23 various software instructions. A profiling tool tracks and identifies the instructions
24 being executed on the processor and generates an association between the
25 instructions and the power consumed during execution of those instructions. The

1 association is a profile represented, for example, as a table or a graph that
2 correlates an amount of power consumed for each instruction executed on the
3 processor. The power profile enables the precise isolation and identification of
4 instructions relative to amounts of power consumed during the execution of those
5 instructions.

6 Advantages of the disclosed systems and methods include providing a way
7 for software developers to isolate sections of code that consume excessive amounts
8 of power while executing. Code sections that consume excessive amounts of
9 power may be amenable to alternate configurations that perform the same function
10 yet reduce the amount of power consumed during execution. Significant power
11 savings can be realized on mobile embedded and other devices through the
12 identification and reconfiguration of such code sections, especially where those
13 code sections execute on a recurrent basis.

14

15 **Exemplary Environment**

16 Fig. 1 illustrates an exemplary development environment 100 that is
17 suitable for implementing power profiling. In the exemplary environment 100, a
18 target device 102 is coupled to a host computer 104 and a power measurement
19 circuit 106 via a data communications bus 108. In the exemplary environment
20 100, the host computer 104 and the power measurement circuit 106 are also
21 coupled via bus 108. Bus 108 is intended to represent any of a variety of general
22 purpose data communications buses including, for example, an I2C (Inter-IC) bus,
23 an SPI (Serial Peripheral Interface) bus, a USB (Universal Serial Bus), and the
24 like. Bus 108 is not a single bus, but is rather made up of several bus instances

25

1 illustrated as 108(a), 108(b) and 108(c), that interconnect devices 102, 104 and
2 106.

3 Target device 102 is intended to represent any of a variety of conventional
4 computing devices. Such devices 102 may include, for example, desktop PCs,
5 notebook or other portable/handheld computers, workstations, servers, mainframe
6 computers, Internet appliances, and so on. However, power profiling may be
7 particularly beneficial in the development of mobile/portable computing devices
8 that are capable of functioning on battery power. Thus, target device 102 is
9 generally discussed throughout this disclosure as being a mobile computing device
10 capable of functioning on battery power.

11 Such mobile devices 102 typically include embedded, hand-held/mobile
12 devices such as PDA's (e.g., Hewlett-Packard's iPAQ, 3Com's PalmPilot, RIM's
13 Blackberry), cell phones, smartphones, and the like. Such embedded, hand-
14 held/mobile devices generally provide more limited computing capabilities than a
15 typical personal computer. Such capabilities may include, for example,
16 information storage and retrieval capabilities for personal or business use,
17 including keeping schedule calendars and address book information. Such devices
18 usually offer some version of an operating system such as, for example, Windows
19 CE. Various applications are available for such devices that provide limited
20 functionality compared to full-fledged versions available for typical personal
21 computers. Thus, mobile, embedded, target devices 102 may include limited
22 versions of email, phone, SMS (short message service), organizer and Web
23 applications. A target device 102 might also include a laptop or notebook
24 computer. Thus, target device 102 may be implemented as a notebook computer
25 running an open platform operating system, such as the Windows® brand operating

1 systems from Microsoft® and various applications for performing common
2 computing functions, such as email, calendaring, task organization, word
3 processing, Web browsing, and so on. An exemplary computing environment for
4 implementing various embodiments of a target device 102 is described in more
5 detail herein below with reference to Fig. 9.

6 Power measurement circuit 106 is a custom circuit capable of measuring
7 power consumption on the target device 102. Power measurement circuit 106
8 enables the measurement of active power consumption in an analog format and the
9 conversion of analog power consumption measurements into a digital format.
10 Power measurement circuit 106 also typically enables the storage of such digitally
11 formatted power consumption information and an ability to communicate this
12 information to a host computer 104 via data communications bus 108(c).

13 Host computer 104 can be any of a variety of conventional computing
14 devices, including desktop PCs, notebook or portable computers, workstations,
15 servers, mainframe computers, Internet appliances, and so on. Host computer 104
16 is generally configured to profile the power consumption on target device 102 with
17 respect to software instructions executing on the device 102. Host computer 104
18 tracks and identifies which software instructions are executing on target device
19 102 at any given time and receives power consumption information from power
20 measurement circuit 106. Host computer 104 generates a power profile that
21 correlates power consumption on target device 102 with the execution of specific
22 software instructions on the device 102. An exemplary computing environment
23 for implementing a host computer 104 is described in more detail herein below
24 with reference to Fig. 9.

25

1 Exemplary Embodiments

2 Fig. 2 illustrates an exemplary embodiment of a target device 102, host
3 computer 104, and power measurement circuit 106 configured to implement power
4 profiling. Target device 102 is implemented as an embedded device 102 and
5 includes a processor 200 and a memory 202. The processor 200 includes a
6 program counter 204. A program counter 204 is a register in the processor 200 that
7 contains the address of the next instruction 206 from memory 202 to be executed.
8 The program counter 204 is automatically incremented after each instruction 206 is
9 fetched in order to point the processor 200 to a subsequent instruction 206. In
10 addition, special instructions may be provided that alter the sequence of execution
11 of instructions 206 by writing a new value to the program counter 204. Such
12 instructions 206 include, for example, JUMP, CALL, and RTS (return from
13 subroutine) instructions. Instructions 206 in memory 202 can include any
14 executable instructions that are part of an operating system, various application
15 programs, device drivers, and so on.

16 Power measurement circuit 106 typically includes an analog to digital
17 converter (ADC) 208, a communications interface 210 and a memory 212. ADC
18 208 is preferably a high precision analog to digital converter such as, for example,
19 a National Semiconductor ADC12662. ADC 208 is typically configured to
20 measure active power consumption of a processor 200 executing instructions 206
21 on embedded device 102. Alternatively, ADC 208 may be configured to measure
22 active power consumption of the entire embedded device 102 during execution of
23 instructions 206 on the device 102. Power consumption is typically measured in
24 either milliamps or milliwatts (mA or mW respectively).

1 Fig. 3 illustrates an example of how a typical ADC 208 on circuit 106 might
2 be coupled to an embedded device 102 to measure power consumption. It is noted
3 that while Fig. 3 illustrates an ADC 208 configured to measure the power
4 consumption of the embedded device 102, it may also be configured to measure
5 the power consumption of various components of the embedded device 102, such
6 as processor 200. ADC 208 generally converts a continuously variable (i.e.,
7 analog) power consumption signal from device 102 into a digital (discrete) form.
8 The analog power consumption signal from device 102 is sampled at a rate that is
9 typically greater than or equal to the rate at which instructions 206 are being
10 executed by processor 200 on embedded device 102. This power sample rate
11 might also be the rate at which a profiler 220 on a host computer 104 samples a
12 program counter 204 on a processor 200 of the embedded device 102, as discussed
13 in greater detail below. The number of digital output states of the ADC 208 is
14 defined by the precision of the ADC 208. For example, a 1amp/12bit ADC 208
15 can provide 4096 different discrete output values, each representing 0.2 millamps
16 (i.e., 1amp/4096) of resolution.

17 Each power consumption value converted to digital form by ADC 208 is
18 typically stored as power consumption data 214 in memory 212 on power
19 measurement circuit 106 prior to being transferred to host computer 104.
20 Communication interface 210 is configured to respond to queries from host
21 computer 104 requesting power consumption data 214 stored in memory 212.
22 Thus, communication interface 210 receives requests from host computer 104 and
23 returns power consumption data 214 from memory 212 to host computer 104 in
24 response to the requests. Communication interface 210 is generally implemented
25

1 as any one of a variety of serial and/or parallel interfaces capable of
2 communicating over bus 108(c) with host computer 104.

3 Host computer 104 includes a processor 216 and memory 218, and in
4 general, can be represented by the exemplary computing environment described in
5 more detail herein below with reference to Fig. 9. Memory 218 includes a power
6 profiler 220 module that is configured to execute on processor 216 to track and
7 identify software instructions 206 executing on embedded device 102. In this
8 respect, power profiler 220 generally resembles current available profiler
9 development tools that use statistical methods to determine which software
10 instructions and components (i.e., groups of instructions) are running at any given
11 moment as well as how long software instructions and components execute.

12 One popular example of a frequently used profiling method is Monte Carlo
13 profiling. In Monte Carlo profiling, a profiler (e.g., power profiler 220) interrupts
14 the system (e.g., processor 200 on embedded device 102) at a very high rate and
15 inspects which software instruction 206 is currently executing. This inspection is
16 implemented through sampling the program counter 204 of the processor 200
17 being interrupted. Using the sampled value of the program counter 204, the
18 profiler 220 scans an instruction lookup table 222 to locate a memory address
19 associated with the program counter 204. In general, lookup table 222 is a
20 mapping between memory locations/addresses and compiled code generated when
21 a compiler compiles source code into machine code. From the memory address,
22 the profiler 220 identifies the software instruction that was executing when the
23 processor 200 was interrupted. After a period of time, the number of “hits” for
24 each software instruction or component is tabulated and a software developer is
25

1 able to better understand which software is utilizing the majority of computation
2 time.

3 Power profiler 220 is additionally configured to query the power
4 measurement circuit 106 to determine the power consumption level of embedded
5 device 102 at any given moment. Power profiler 220 receives power consumption
6 data 214 from power measurement circuit 106 in response to the queries it sends to
7 power measurement circuit 106. Power profiler 220 is adapted to query the power
8 measurement circuit 106 each time it takes a sample of the program counter 204 as
9 discussed above. Thus, each time the power profiler 220 samples the program
10 counter 204 to identify a software instruction executing on processor 200, it
11 queries the power measurement circuit 106 and receives a value from power
12 consumption data 214 that has been measured during the execution of the software
13 instruction on processor 200. Alternatively, power profiler 220 may query the
14 power measurement circuit 106 at intervals and receive groups of values of power
15 consumption data 214 which it then correlates with identified software instructions
16 executed on processor 200. Thus, power consumption data 214 may be received as
17 one value per query sent in real time from power profiler 220, or it may be
18 received as a group of power consumption values that have been previously stored
19 in memory 212 on power measurement circuit 106.

20 Power profiler 220 is also configured to correlate the power consumption
21 data 214 received from power measurement circuit 106 with the software
22 instructions 206 executing on processor 200 of embedded device 102. Power
23 profiler 220 generates a power profile 224 that quantifies the power consumed for
24 the precise software instruction executing on processor 200 of embedded device
25 102. A power profile 224 can be represented in various forms including, for

1 example, a table or a graph that provide pairs of information identifying software
2 instructions with corresponding power consumption values measured during the
3 execution of the identified software instructions.

4 Fig. 4 illustrates an example of a graphical user interface that might be
5 generated by power profiler 224 to communicate information in a power profile
6 224 to a developer. The power profile 224 illustrated in Fig. 4 is shown in the
7 form of a graph that depicts a correlation between levels of power consumption
8 400 and various software instructions 402 from various applications executing on
9 an embedded device 102. The thick horizontal lines in the top half 404 of the
10 graph are intended to indicate which software instructions 402 are currently
11 executing. The thick horizontal lines in the bottom half 406 of the graph are
12 intended to indicate the level of power consumed during the execution of the
13 currently executing software instruction as indicated in the top half of the graph.
14 For example, when the instruction, “shell.exe<<0x2DFD098E>>” 408 executes,
15 the power consumption is approximately 90 mA 410, while when instruction the
16 “CEMGR.C.exe<<0x6DDE76>>” 412 executes, the power consumption is
17 approximately 50 mA 414.

18 In general, the power profiling information presented to a developer in a
19 power profile 224 such as that shown in Fig. 4 can help a developer identify “hot
20 spots” in code where there are increases in runtime power consumption on a
21 mobile device 102. For example, in the Fig. 4 profile, when
22 “readdr.exe<<0xCD07A2CE>>” 416 is executing, the power consumption
23 increases dramatically because of a function call into “NK.exe<<0x0DFFF002>>”
24 418. Consequently, a developer may find it advantageous to eliminate
25 “NK.exe<<0x0DFFF002>>” 418 function call if possible in order to save power.

1 As developers profile the runtime power consumption of their software
2 modules using power profiles 224 such as that shown in Fig. 4, they should be able
3 to identify certain generic programming constructs and algorithms that are more
4 power-usage friendly than others. For example, a frequently executing algorithm
5 that uses recursion might consume more power than one that uses iteration.
6 Likewise, polling might consume less power than waiting for an interrupt, or,
7 preventing unnecessary context switches may dramatically reduce power, and so
8 on. Furthermore, by using very high-precision profiling data it may be possible to
9 identify specific hardware-dependent CPU instructions that use more power than
10 others.

11 Fig. 5 illustrates another exemplary embodiment of a target device 102, host
12 computer 104, and power measurement circuit 106 configured to implement power
13 profiling. As in the previous embodiment of Fig. 2, target device 102 is
14 implemented as an embedded device 102. In addition, the embedded device 102 of
15 Fig. 5 is generally configured to operate as discussed above. However, in the Fig.
16 5 embodiment, embedded device 102 includes the power measurement circuit 106.
17 Power measurement circuit 106 functions in a manner similar to that discussed
18 above with respect to the Fig. 2 embodiment. However, because the power
19 measurement circuit 106 is integrated into embedded device 102, in one
20 implementation it may share various components of the embedded device 102 such
21 as memory 202. As an example, Fig. 5 illustrates power consumption data 214 as
22 being stored by power measurement circuit 106 in memory 202 on embedded
23 device 102.

24

25

Exemplary Methods

1 Example methods for implementing power profiling in an environment such
2 as the exemplary development environment 100 of Fig. 1 will now be described
3 with primary reference to the flow diagrams of Figs. 6 - 8. The methods apply
4 generally to the exemplary embodiments discussed above with respect to Figs. 2 -
5 5. The elements of the described methods may be performed by any appropriate
6 means including, for example, by hardware logic blocks on an ASIC or by the
7 execution of processor-readable instructions defined on a processor-readable
8 medium.

9 A "processor-readable medium," as used herein, can be any means that can
10 contain, store, communicate, propagate, or transport instructions for use by or
11 execution by a processor. A processor-readable medium can be, without
12 limitation, an electronic, magnetic, optical, electromagnetic, infrared, or
13 semiconductor system, apparatus, device, or propagation medium. More specific
14 examples of a processor-readable medium include, among others, an electrical
15 connection (electronic) having one or more wires, a portable computer diskette
16 (magnetic), a random access memory (RAM) (magnetic), a read-only memory
17 (ROM) (magnetic), an erasable programmable-read-only memory (EPROM or
18 Flash memory), an optical fiber (optical), a rewritable compact disc (CD-RW)
19 (optical), and a portable compact disc read-only memory (CDROM) (optical).

20 Fig. 6 shows an exemplary method 600 for implementing power profiling of
21 software instructions executing on a processor. The processor is generally a
22 component of an embedded device 102 that is capable of operating on battery
23 power. At block 602, instructions executing on a processor are identified. The
24 identification process is generally discussed below with respect to method 700,
25 which is an extension of method 600.

1 At block 604 of method 600, power consumption data is received from a
2 power measurement circuit 106. The power measurement circuit 106 is typically
3 part of a software development board or it may be resident on the embedded
4 device 102 itself. The power measurement circuit 106 is typically configured to
5 measure the power consumption of the processing circuitry being implemented to
6 execute various software instructions on the embedded device 102, but it can also
7 be configured to measure power consumption of the entire embedded device 102.
8 A host computer 104 running a power profiler 220 typically receives the power
9 consumption data upon querying the power measurement circuit. However, the
10 host computer 104 might receive power consumption data from the power
11 measurement circuit automatically at some fixed interval.

12 At block 606, the power consumption data is correlated with the identified
13 instructions. The power profiler 220 executing on the host computer 104
14 associates each instruction that executes on the embedded device 102 with a
15 measured amount of power (i.e., measure by the power measurement circuit 106)
16 being consumed by the processing circuitry of the embedded device 102 during the
17 execution of each identified instruction. The power profiler 220 generates a power
18 profile that tracks the power being consumed on the embedded device 102 due to
19 the execution of the software instructions. Therefore, the power profile typically
20 includes numerous power consumption values each associated with an identified
21 software instruction that has executed on the embedded device 102. The power
22 profile can be implemented in various forms, including for example, a table having
23 pairs of data that match power consumption values with identified software
24 instructions, or a graph that visually correlates power consumption values with
25 identified software instructions.

1 Fig. 7 shows an exemplary method 700 for implementing power profiling of
2 software instructions that is an extension of method 600. Method 700 extends
3 from block 602 of method 600, and generally describes the identification of
4 software instructions executing on a processor. The processor is generally a
5 component of an embedded device 102 that is capable of operating on battery
6 power. At block 702 of method 700, the processor is interrupted. Typically, the
7 processor is executing software instructions in a runtime environment when it is
8 interrupted. The interrupt comes from a host computer 104 executing a power
9 profiler 220.

10 At block 704, the program counter on the processor is sampled. The
11 program counter is a register in the processor that contains the address of the next
12 software instruction from memory to be executed. In general, it is the value of the
13 program counter that permits the power profiler 220 executing on the host
14 computer 104 to identify which instruction is executing when the processor is
15 interrupted. At block 706, a lookup table is scanned to determine the address in
16 memory indicated by the program counter. The lookup table is a table generated
17 during a previous compilation of the software instructions that are stored on the
18 embedded device. The host computer 104 is typically the computer on which the
19 embedded device 102 software is compiled. Therefore, the lookup table is resident
20 on the host computer 104 and permits the identification of the exact instruction
21 executing on the embedded device 102 when the processor on the embedded
22 device 102 is interrupted and its program counter is sampled.

23 At block 708, the software instruction is identified which resides at the
24 memory address determined from the program counter. The software instruction
25

1 might be an instruction from any number of routines or applications running on the
2 embedded device 102.

3 Fig. 8 shows another exemplary method 800 for implementing power
4 profiling of software instructions executing on a processor of an embedded device.
5 At block 802, the power consumption of software instructions executing on an
6 embedded device is measured. A power measurement circuit 106 is typically
7 configured to measure the power consumption of a processor executing the
8 software instructions. However, the power measurement circuit 106 may also be
9 configured to measure power consumption of the entire embedded device 102
10 during execution of the software instructions by the processor on the embedded
11 device. The power measurement circuit may be integrated into the embedded
12 device, or it may be a part of a software development test board.

13 At block 804, analog power consumption measurements from the embedded
14 device 102 are converted into digital measurements. The analog to digital
15 conversion is typically implemented by a high precision analog to digital converter
16 (ADC) 208 such as a National Semiconductor ADC12662. At block 806, the
17 digital power measurements are stored in a memory on the power measurement
18 circuit 106. At block 808, the power measurement circuit 106 receives a request
19 from a host computer 104 to transmit power consumption data. Requests may be
20 received as frequently as the execution of each instruction on processor 200 of
21 embedded device 102. Requests may also be received at intervals. At block 810,
22 the power measurement circuit 106 responds to the request(s) by transmitting
23 digital power consumption measurements to the host computer 104. The power
24 consumption data transferred may be transmitted one measurement at a time, or in
25

1 groups of measurements. The transmissions can depend on the nature of the
2 request from host computer 104.

3 While one or more methods have been disclosed by means of flow diagrams
4 and text associated with the blocks of the flow diagrams, it is to be understood that
5 the blocks do not necessarily have to be performed in the order in which they were
6 presented, and that an alternative order may result in similar advantages.
7 Furthermore, the methods are not exclusive and can be performed alone or in
8 combination with one another.

9

10

11 **Exemplary Computer**

12 Fig. 9 illustrates an exemplary computing environment suitable for
13 implementing various embodiments of a target device 102 and a host computer
14 104. Although one specific configuration is shown, a target device 102 and a host
15 computer 104 may be implemented in other computing configurations. For
16 example, the exemplary computing environment of Fig. 9 is generally a more
17 developed computing environment than might typically be employed for specific
18 implementations of a target device 102.

19 The computing environment 900 includes a general-purpose computing
20 system in the form of a computer 902. The components of computer 902 can
21 include, but are not limited to, one or more processors or processing units 904, a
22 system memory 906, and a system bus 908 that couples various system
23 components including the processor 904 to the system memory 906.

1 The system bus 908 represents one or more of any of several types of bus
2 structures, including a memory bus or memory controller, a peripheral bus, an
3 accelerated graphics port, and a processor or local bus using any of a variety of bus
4 architectures. An example of a system bus 908 would be a Peripheral Component
5 Interconnects (PCI) bus, also known as a Mezzanine bus.

6 Computer 902 typically includes a variety of computer readable media.
7 Such media can be any available media that is accessible by computer 902 and
8 includes both volatile and non-volatile media, removable and non-removable
9 media. The system memory 906 includes computer readable media in the form of
10 volatile memory, such as random access memory (RAM) 910, and/or non-volatile
11 memory, such as read only memory (ROM) 912. A basic input/output system
12 (BIOS) 914, containing the basic routines that help to transfer information between
13 elements within computer 902, such as during start-up, is stored in ROM 912.
14 RAM 910 typically contains data and/or program modules that are immediately
15 accessible to and/or presently operated on by the processing unit 904.

16 Computer 902 can also include other removable/non-removable,
17 volatile/non-volatile computer storage media. By way of example, Fig. 9
18 illustrates a hard disk drive 916 for reading from and writing to a non-removable,
19 non-volatile magnetic media (not shown), a magnetic disk drive 918 for reading
20 from and writing to a removable, non-volatile magnetic disk 920 (e.g., a “floppy
21 disk”), and an optical disk drive 922 for reading from and/or writing to a
22 removable, non-volatile optical disk 924 such as a CD-ROM, DVD-ROM, or other
23 optical media. The hard disk drive 916, magnetic disk drive 918, and optical disk
24 drive 922 are each connected to the system bus 908 by one or more data media
25 interfaces 926. Alternatively, the hard disk drive 916, magnetic disk drive 918, and

1 optical disk drive 922 can be connected to the system bus 908 by a SCSI interface
2 (not shown).

3 The disk drives and their associated computer-readable media provide non-
4 volatile storage of computer readable instructions, data structures, program
5 modules, and other data for computer 902. Although the example illustrates a hard
6 disk 916, a removable magnetic disk 920, and a removable optical disk 924, it is to
7 be appreciated that other types of computer readable media which can store data
8 that is accessible by a computer, such as magnetic cassettes or other magnetic
9 storage devices, flash memory cards, CD-ROM, digital versatile disks (DVD) or
10 other optical storage, random access memories (RAM), read only memories
11 (ROM), electrically erasable programmable read-only memory (EEPROM), and
12 the like, can also be utilized to implement the exemplary computing system and
13 environment.

14 Any number of program modules can be stored on the hard disk 916,
15 magnetic disk 920, optical disk 924, ROM 912, and/or RAM 910, including by
16 way of example, an operating system 926, one or more application programs 928,
17 other program modules 930, and program data 932. Each of such operating system
18 926, one or more application programs 928, other program modules 930, and
19 program data 932 (or some combination thereof) may include an embodiment of a
20 caching scheme for user network access information.

21 Computer 902 can include a variety of computer/processor readable media
22 identified as communication media. Communication media typically embodies
23 computer readable instructions, data structures, program modules, or other data in
24 a modulated data signal such as a carrier wave or other transport mechanism and
25 includes any information delivery media. The term "modulated data signal" means

1 a signal that has one or more of its characteristics set or changed in such a manner
2 as to encode information in the signal. By way of example, and not limitation,
3 communication media includes wired media such as a wired network or direct-
4 wired connection, and wireless media such as acoustic, RF, infrared, and other
5 wireless media. Combinations of any of the above are also included within the
6 scope of computer readable media.

7 A user can enter commands and information into computer system 902 via
8 input devices such as a keyboard 934 and a pointing device 936 (e.g., a “mouse”).
9 Other input devices 938 (not shown specifically) may include a microphone,
10 joystick, game pad, satellite dish, serial port, scanner, and/or the like. These and
11 other input devices are connected to the processing unit 904 via input/output
12 interfaces 940 that are coupled to the system bus 908, but may be connected by
13 other interface and bus structures, such as a parallel port, game port, or a universal
14 serial bus (USB).

15 A monitor 942 or other type of display device can also be connected to the
16 system bus 908 via an interface, such as a video adapter 944. In addition to the
17 monitor 942, other output peripheral devices can include components such as
18 speakers (not shown) and a printer 946 which can be connected to computer 902
19 via the input/output interfaces 940.

20 Computer 902 can operate in a networked environment using logical
21 connections to one or more remote computers, such as a remote computing device
22 948. By way of example, the remote computing device 948 can be a personal
23 computer, portable computer, a server, a router, a network computer, a peer device
24 or other common network node, and the like. The remote computing device 948 is
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1 illustrated as a portable computer that can include many or all of the elements and
2 features described herein relative to computer system 902.

3 Logical connections between computer 902 and the remote computer 948
4 are depicted as a local area network (LAN) 950 and a general wide area network
5 (WAN) 952. Such networking environments are commonplace in offices,
6 enterprise-wide computer networks, intranets, and the Internet. When
7 implemented in a LAN networking environment, the computer 902 is connected to
8 a local network 950 via a network interface or adapter 954. When implemented in
9 a WAN networking environment, the computer 902 typically includes a modem
10 956 or other means for establishing communications over the wide network 952.
11 The modem 956, which can be internal or external to computer 902, can be
12 connected to the system bus 908 via the input/output interfaces 940 or other
13 appropriate mechanisms. It is to be appreciated that the illustrated network
14 connections are exemplary and that other means of establishing communication
15 link(s) between the computers 902 and 948 can be employed.

16 In a networked environment, such as that illustrated with computing
17 environment 900, program modules depicted relative to the computer 902, or
18 portions thereof, may be stored in a remote memory storage device. By way of
19 example, remote application programs 958 reside on a memory device of remote
20 computer 948. For purposes of illustration, application programs and other
21 executable program components, such as the operating system, are illustrated
22 herein as discrete blocks, although it is recognized that such programs and
23 components reside at various times in different storage components of the
24 computer system 902, and are executed by the data processor(s) of the computer.

1 **Conclusion**

2 Although the invention has been described in language specific to structural
3 features and/or methodological acts, it is to be understood that the invention
4 defined in the appended claims is not necessarily limited to the specific features or
5 acts described. Rather, the specific features and acts are disclosed as exemplary
6 forms of implementing the claimed invention.

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